Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					ınder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
1752-21.1 IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x				lard	Form Type Distribute	Form Type * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information						n		
Supplier	Information													
Company name*			Company uni	Company unique ID			Unique ID Autho	rity		Respo	Response Date*			
onsemi									2024-0	2024-05-15				
Contact Name			Title - Contac	Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized	Authorized Representative*			Title - Representative			Phone - Representative*				Email - Representative*			
Product-E	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date	Version	Manufacturing Site	Manufacturing Site		UOM	Unit Type		
FSA5157		ZL6X SPDT Analog Switch		vitch		2024-05-15		TH2		2.0707	mg	Each		
Manufac	Manufacturing Process Information													
Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020		J-STD-020 MS	L Rating	g Peak Process Body Temperature Max Time at		rature Max Time at Pea	eak Temperature Number of Reflow Cycles				
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		30 se		seconds 3			
Comments														
level 1 - maximum time at peak temperature during soldering is 10-30 seconds														
For more i	information regarding material co	mposition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appli											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.1165	mg	Supplier	Silicon (Si)	7440-21-3		0.1165	mg
Die Attach	0.0146	mg	Supplier	Diethylene glycol monoethyl ether acetate	112-15-2		0.0037	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0037	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0072	mg
Lead Frame	0.7075	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0013	mg
			Supplier	Silicon (Si)	7440-21-3		0.0052	mg
			В	Nickel (Ni)	7440-02-0		0.023	mg
			Supplier	Copper (Cu)	7440-50-8		0.678	mg
Mold Compound-Black	1.21	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0786	mg
			Supplier	Carbon Black (C)	1333-86-4		0.006	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.0648	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0605	mg
Plating	0.0099	mg	Supplier	Palladium (Pd)	7440-05-3		0.0007	mg
-			В	Nickel (Ni)	7440-02-0		0.0091	mg
			Supplier	Gold (Au)	7440-57-5		0.0001	mg
Wire Bond	0.0122	mg	Supplier	Palladium (Pd)	7440-05-3		0.0001	mg
			Supplier	Gold (Au)	7440-57-5		0.0121	mg